

ARGONNE: LGAD CONSORTIUM INTERESTS

EIC PROJECT INTERESTS

TOPSiDE: Timing Optimized PID Silicon Detector

- TOF/PID/4D Detector concept

Or Implementation of a silicon detector using LGAD's

- Optimizing a 4D detector design concept using simulation framework
- R&D of sensors/modules
 - AC LGAD's
 - Reaching 10 ps timing resolution
 - LGAD related Electronics (CFD?)
 - Monolithic implementation of an LGAD??
- Interested to take a large construction role in an LGAD detector subsystem

ACTIVITIES, EXPERTISE, PERSON-POWER

Now: LGAD Testing

- Sensors from HPK (via UCSC) and BNL
 - Probing, test beam, test bench characterization
- TCAD design
- Electronics design development

Future: Detector design, validation, construction

Module assembly & testing, electronics, mechanical design, cooling, DAQ

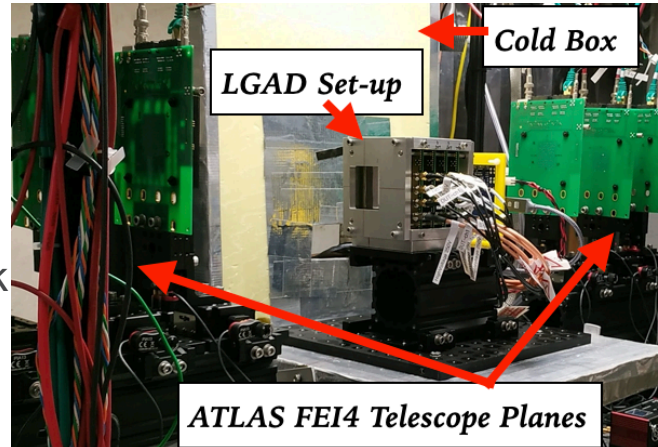
- Engineers, technicians, scientists with relevant experience

Person-power: ~4 scientists (fraction), 1 postdoc, electrical engineer coming on-board now shared w/ UCSC

→ Able to ramp up with more scientists, engineers, etc. with EIC project support

EQUIPMENT AVAILABLE

- Pixel Telescope @ Fermilab
 - 72 μm x 13 μm resolution
 - Future upgrade foreseen
- Large clean room
 - Probe station w/ cold chuck
 - Edge-TCT
 - Wire bonders
 - Thermal chamber
 - 3D microscope
 - Smartscope
 - Clean storage room



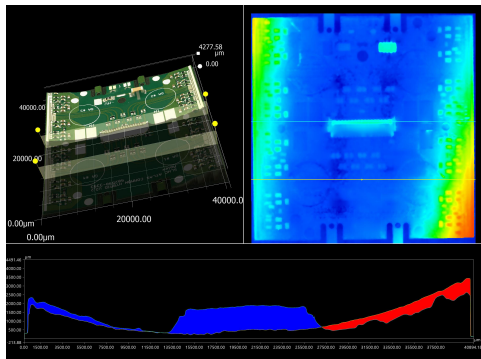
4,000 sq ft Class 10k clean room



Probe station w/
thermal chuck

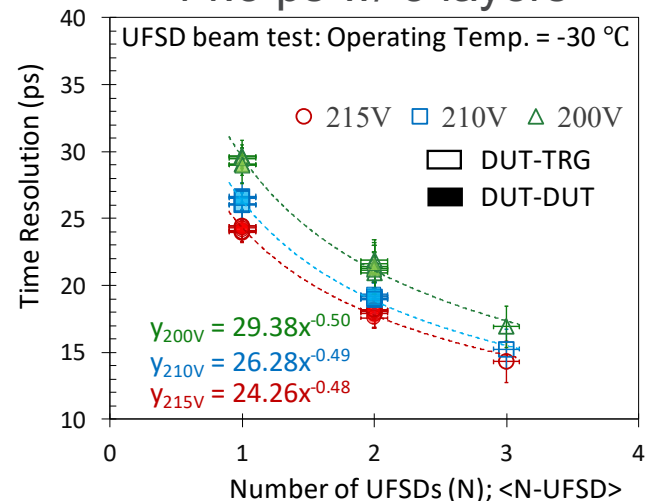
EQUIPMENT CONT.

3D microscope



Hesse BJ855 wire bonder

Test beam results at -30 C: 14.3 ps w/ 3 layers



<https://arxiv.org/abs/2010.02499>
Submitted to JINST